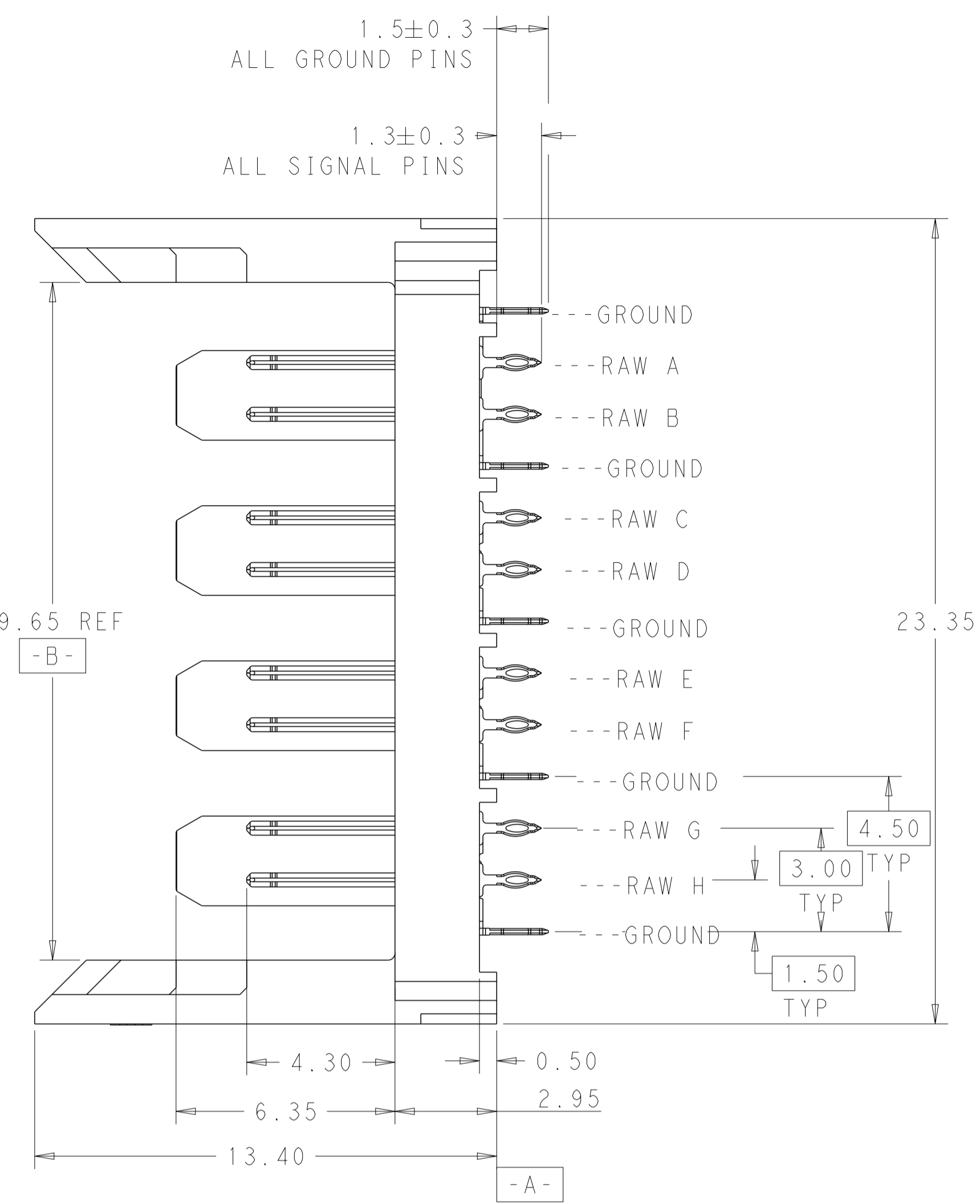
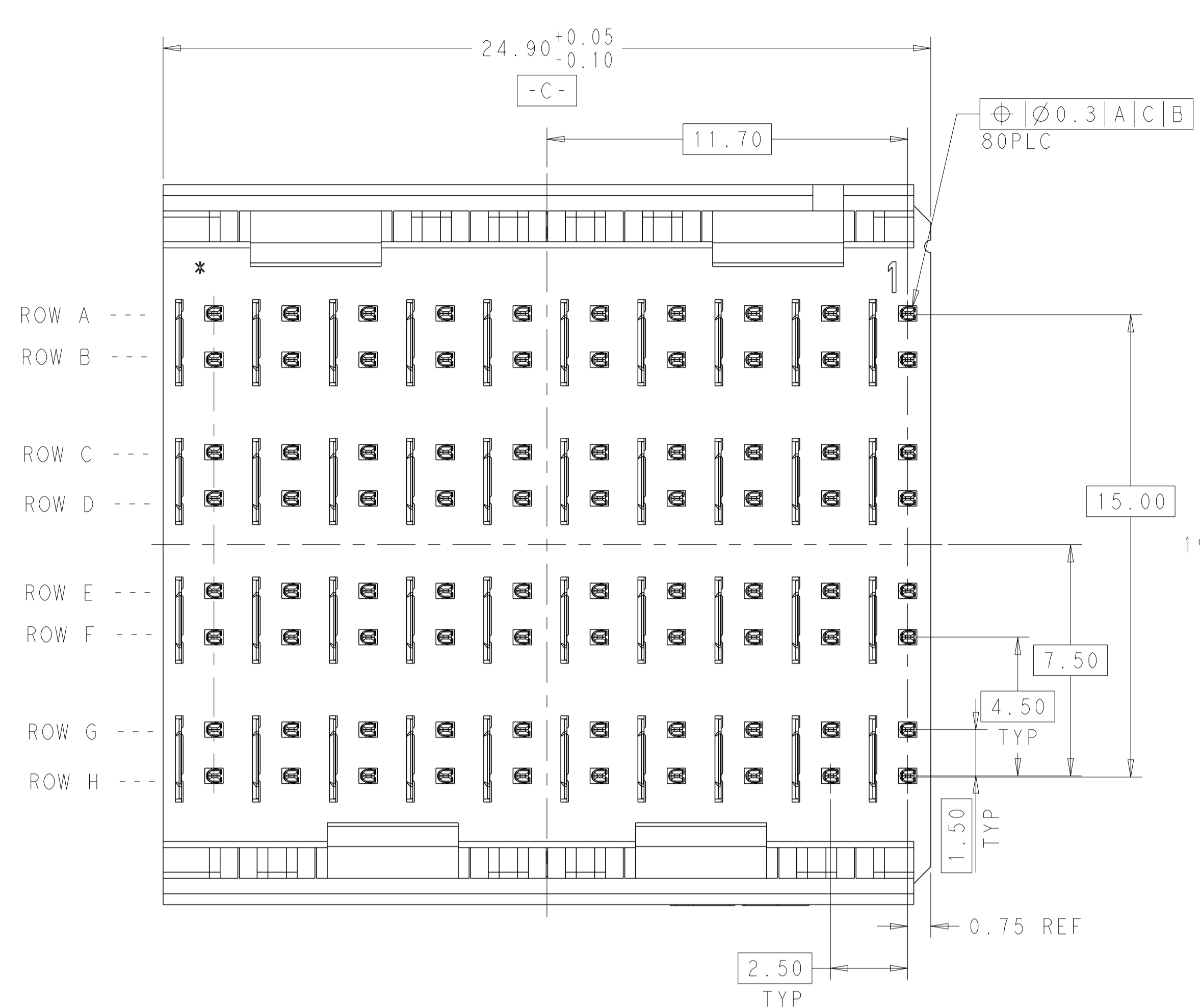
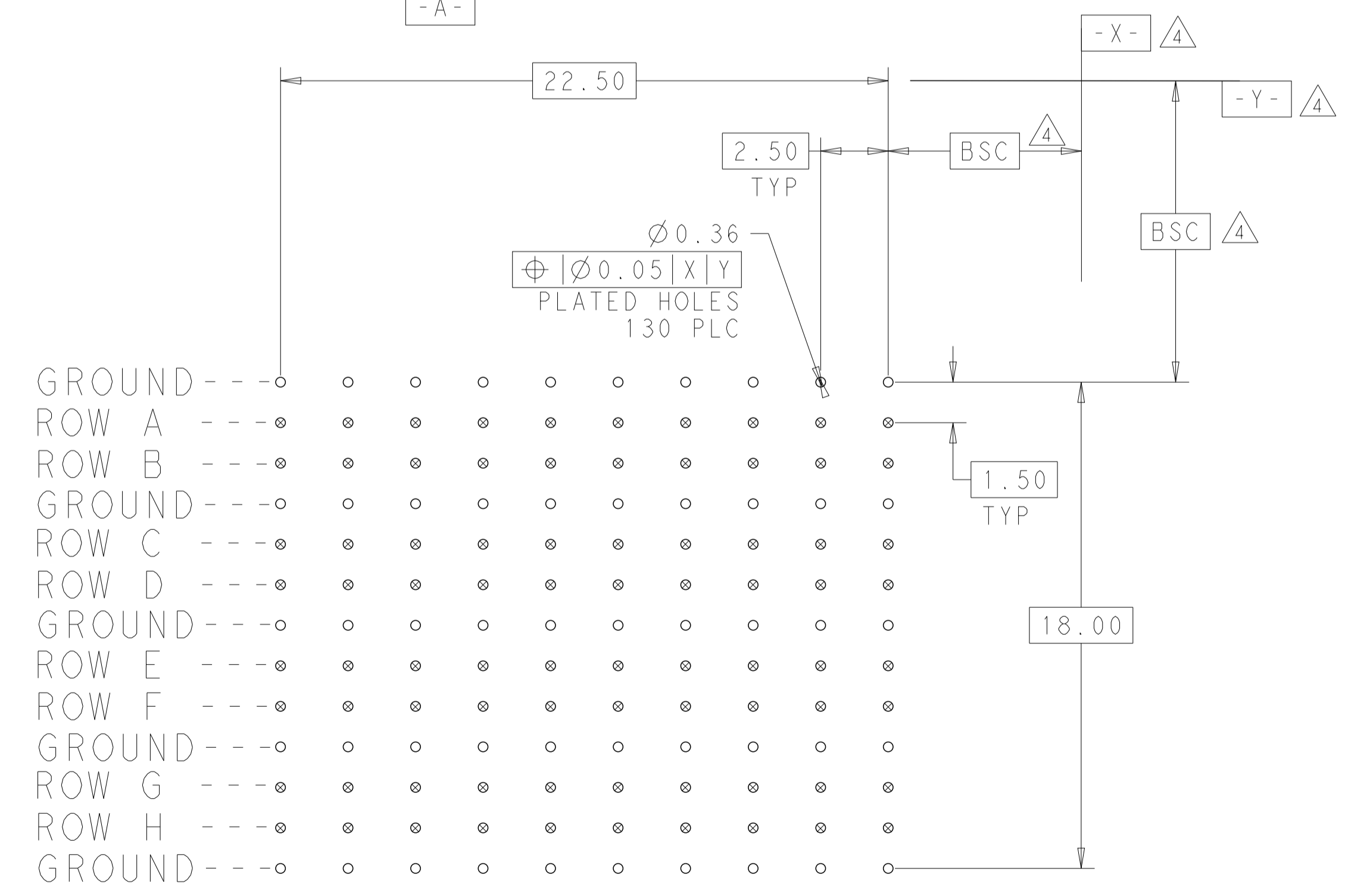
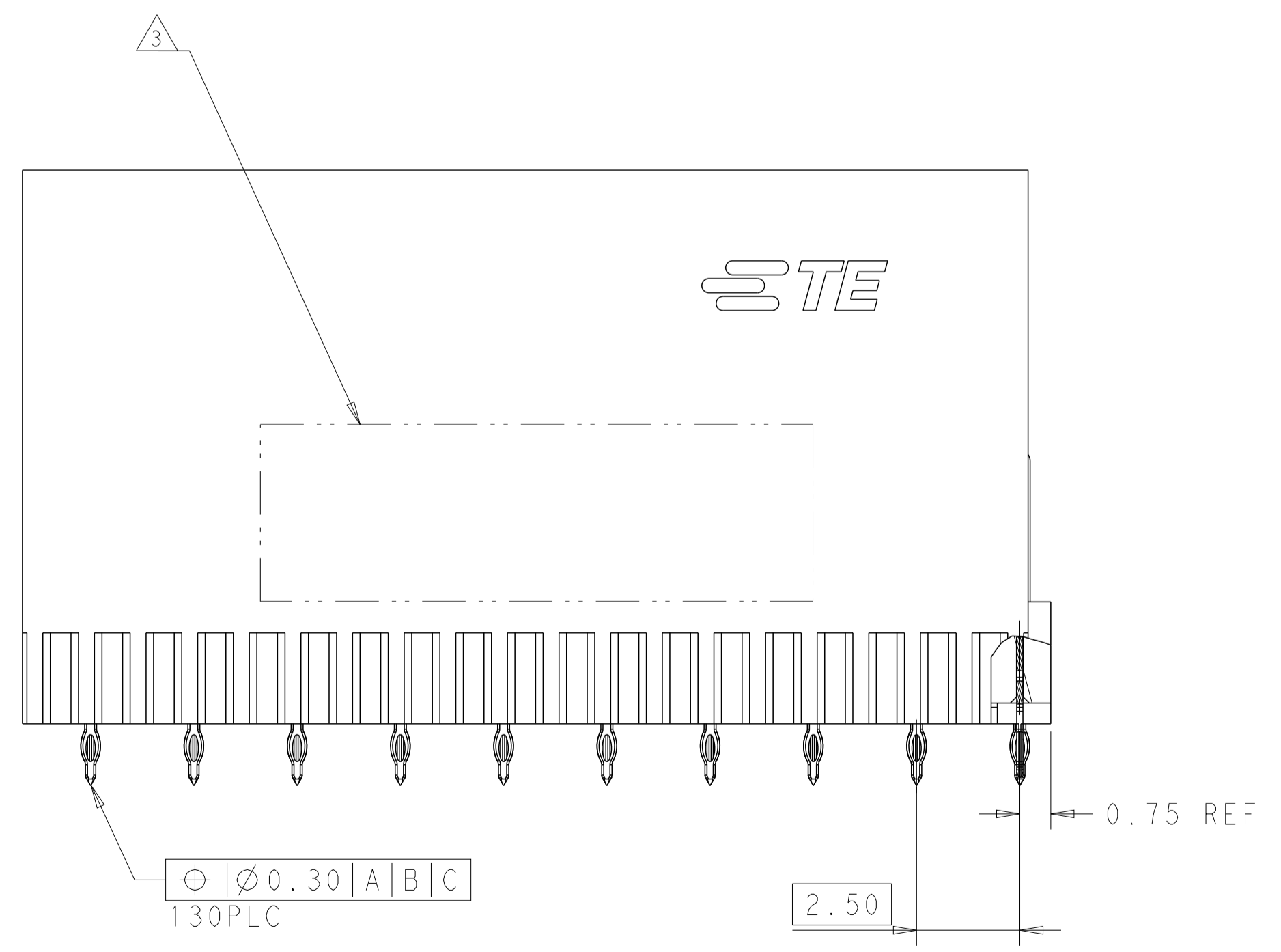


REVISIONS				
P	LTN	DESCRIPTION	DATE	APVD
A		INITIAL RELEASE	19MAR15	D.S F.Y



- 1 MATERIAL:
CONTACT AND SHIELD: COPPER ALLOY
HOUSING: THERMALPLASTIC, UL 94V-0
- 2 FINISH: SIGNAL AND GROUND CONTACTS:
MATING AREA: MEETS THE PERFORMANCE REQUIREMENTS OF
PRODUCT SPECIFICATION 108-60103; BASED ON TELCORDIA
GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS
COMPLIANT PIN AREA: 0.5 um MIN MATTE
TIN OVER BASE PLATING
- 3 CONNECTOR MARKED WITH PART NUMBER AND DATE CODE
- 4 DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER
- 5 CONTACT AREA LUBRICATED WITH BELLCORE
APPROVED LUBRICANT. TECHNICAL REFERENCE:
GR-1217-CORE, ISSUE 2, DECEMBER 2008.
- 6 RECOMMENDED THRU HOLE DIAMETER AND PLATING THICKNESSES PLEASE
REFER TO APPLICATION SPEC 114-13059



SECTION J-J

RECOMMENDED PCB LAYOUT
 =====
 VIEW FROM COMPONENT SIDE

2170902-1
 PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN: DAVID SHEN 18DECT4	TE Connectivity
DIMENSIONS: mm		CHK: FRANK YANG 18DECT4	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APP'D: FRANK YANG 18DECT4	NAME: ASSEMBLY DRAWING, HM-eZD+ VERTICAL, HEADER, 4PAIRS 10COLUMNS
0 PLC ±0.2 1 PLC ±0.1 3 PLC ±0.05 4 PLC ±0.05 ANGLES ±°		PRODUCT SPEC: 108-60103	
MATERIAL: -		APPLICATION SPEC: 114-13059	SIZE: A1
FINISH: -		WEIGHT: -	RESTRICTED TO: -
Customer Drawing		SCALE: -	SHEET 1 OF 1 REV A

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)